

Compact Video Driver Series for DSCs and Portable Devices



Ultra-compact Waferlevel Chip Size Package Output Capacitor-less Single Output Video Drivers

BH76906GU, BH76909GU, BH76912GU, BH76916GU, BH76706GU

No. 09064EAT01

●Description

Due to a built-in charge pump circuit, this video driver does not require the large capacity tantalum capacitor at the video output pin that is essential in conventional video drivers. Features such as a built-in LPF that has bands suited to mobile equipment, current consumption of 0 μ A at standby, and low voltage operation from as low as 2.5 V make it optimal for digital still cameras, mobile phones, and other equipment in which high density mounting is demanded.

●Features

- 1) WLCSP ultra-compact package (1.6 mm x 1.6 mm x 0.75 mm)
- 2) Improved noise characteristics over BH768xxFVM series
- 3) Four video driver amplifier gains in lineup: 6 dB, 9 dB, 12 dB, 16.5 dB
- 4) Large output video driver of maximum output voltage 5.2 Vpp. Ample operation margin for supporting even low voltage operation
- 5) Output coupling capacitor not needed, contributing to compact design
- 6) Built-in standby function and circuit current of 0 μ A (typ) at standby
- 7) Clear image playback made possible by built-in 8th-order 4.5 MHz LPF
- 8) Due to use of bias input format, supports not only video signals but also chroma signals and RGB signals
- 9) Due to built-in output pin shunt switch, video output pin can be used as video input pin (BH76706GU)

●Applications

Mobile phone, digital still camera, digital video camera, hand-held game, portable media player

●Line up matrix

Product Name	Video Driver Amplifier Gain	Recommended Input Level	Video Output Pin Shunt Function
BH76906GU	6dB	1Vpp	—
BH76909GU	9dB	0.7Vpp	
BH76912GU	12dB	0.5Vpp	
BH76916GU	16.5dB	0.3Vpp	
BH76706GU	6dB	1Vpp	O

●Absolute Maximum Ratings (Ta = 25 °C)

Parameter	Symbol	Rating	Unit
Supply voltage	V _{cc}	3.55	V
Power dissipation	P _d	580	mW
Operating temperature range	T _{opr}	-40~+85	°C
Storage temperature range	T _{stg}	-55~+125	°C

* When mounted on a 50 mm×58 mm×1.6 mm glass epoxy board, reduce by 5.8mW/°C above Ta=+25°C.

●Operating Range

Parameter	Symbol	Min.	Typ.	Max.	Unit
Supply voltage	V _{CC}	2.5	3.0	3.45	V

●Electrical Characteristics

[Unless otherwise specified, Typ. : T_a = 25 °C, V_{CC} = 3V]

Parameter	Symbol	Typical Values					Unit	Measurement Conditions
		BH76906 GU	BH76909 GU	BH76912 GU	BH76916 GU	BH76706 GU		
Circuit current 1-1	I _{CC1-1}	15.0					mA	In active mode (No signal)
Circuit current 1-2	I _{CC1-2}	17.0					mA	In active mode (Outputting NTSC color bar signal)
Circuit current 2	I _{CC2}	0.0					μA	In standby mode
Circuit current 3	I _{CC3}	—				100	μA	In input mode (Applying B3 = 1.5 V)
Standby switch input current High Level	I _{thH1}	45				—	μA	Applying B3 = 3.0 V
Standby switch switching voltage High Level	V _{thH1}	1.2V _{min}					V	Active mode
Standby switch switching voltage Low Level	V _{thL1}	0.45V _{max}					V	Standby mode
Standby switch outflow current High Level	I _{thH2}	—				0	μA	Applying B3 = 3.0 V
Standby switch outflow current Middle Level	I _{thM2}					8	μA	Applying B3 = 1.5 V
Standby switch outflow current Low Level	I _{thL2}					23	μA	Applying B3 = 0 V
Mode switching voltage High Level	V _{thH2}					V _{CC} -0.2 (MIN.)	V	Standby mode
Mode switching voltage Middle Level	V _{thM2}					V _{CC} /2 (TYP.)	V	Input mode
Mode switching voltage low Level	V _{thL2}					0.2 (MAX.)	V	Active mode
Voltage gain	G _V	6.0	9.0	12.0	16.5	6.0	dB	V _o =100kHz, 1.0V _{pp}
Maximum output level	V _{omv}	5.2					V _{pp}	f=10kHz, THD=1%
Frequency characteristic 1	G _{f1}	-0.2				-0.2	dB	f=4.5MHz/100KHz
Frequency characteristic 2	G _{f2}	-1.5				-1.4	dB	f=8.0MHz/100KHz
Frequency characteristic 3	G _{f3}	-26				-28	dB	f=18MHz/100KHz
Frequency characteristic 4	G _{f4}	-44				-48	dB	f=23.5MHz/100KHz
Differential gain	D _G	0.5					%	V _o =1.0V _{p-p} Inputting standard staircase Signal
Differential phase	D _P	1.0					deg	V _o =1.0V _{p-p} Inputting standard staircase signal
Y signal to noise ratio	SN _Y	+74	+73	+70	+70	+74	dB	100 kHz~6MHz band Inputting 100% white video signal
C AM signal to noise ratio	SN _{CA}	+77	+76	+75	+75	+77	dB	100~500 kHz band Inputting 100% chroma video signal
C PM signal to noise ratio	SN _{CP}	+65					dB	100~500 kHz band Inputting 100% chroma video signal
Current able to flow into output pin	I _{extin}	30					mA	Applying 4.5 V to output pin through 150 Ω
Output DC offset	V _{off}	±50 _{max}					mV	With no signal V _{off} = (V _{out} pin voltage) ÷ 2
Input impedance	R _{in}	150					kΩ	Measure inflowing current when applying A3 = 1 V
Output pin shunt switch on resistance	R _{on}	—				3	Ω	

●Test Circuit Diagram

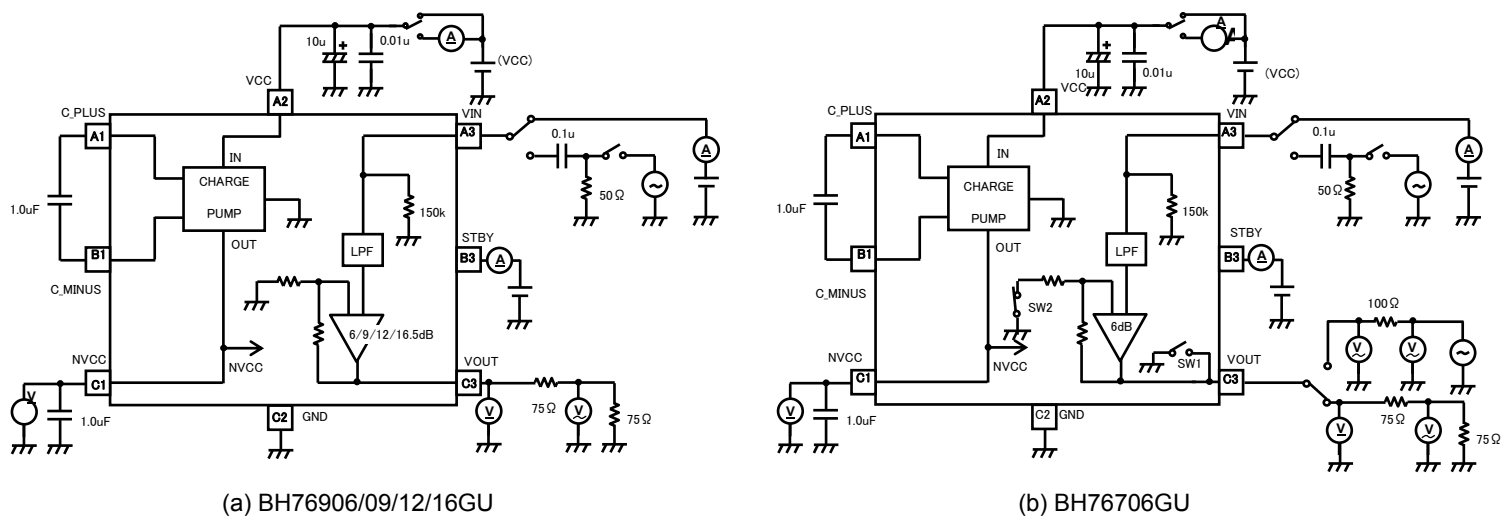


Fig. 1

※ A test circuit is a circuit for shipment inspection and differs from an application circuit example.

●Block Diagram

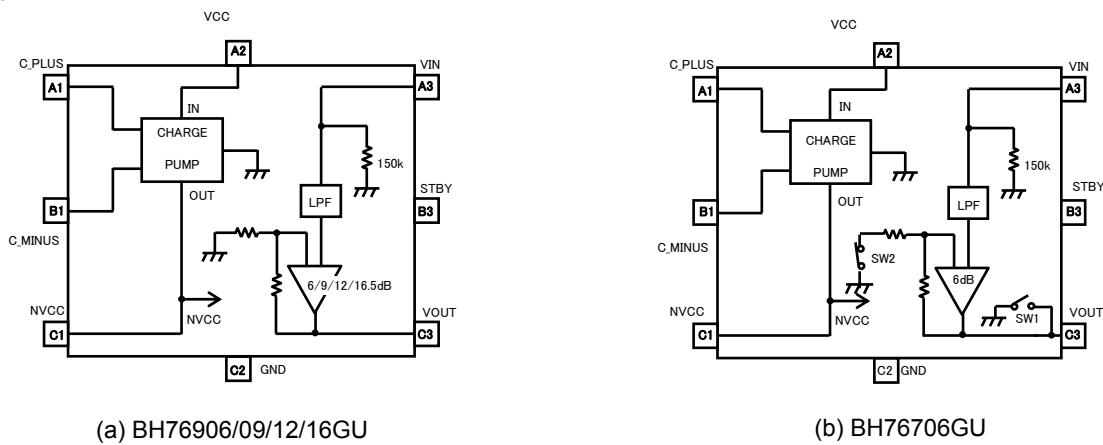


Fig. 2

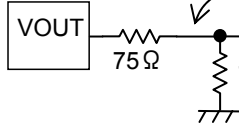
●Operation Logic

BH769xxGU	
STBY Pin Logic	Operating Mode
H	Active
L	Standby
OPEN	

BH76706GU			
STBY Pin Logic	Operating Mode	SW1	SW2
H	Standby	OFF	OFF
M	Input (Record)	ON	OFF
L	Active (Playback)	OFF	ON

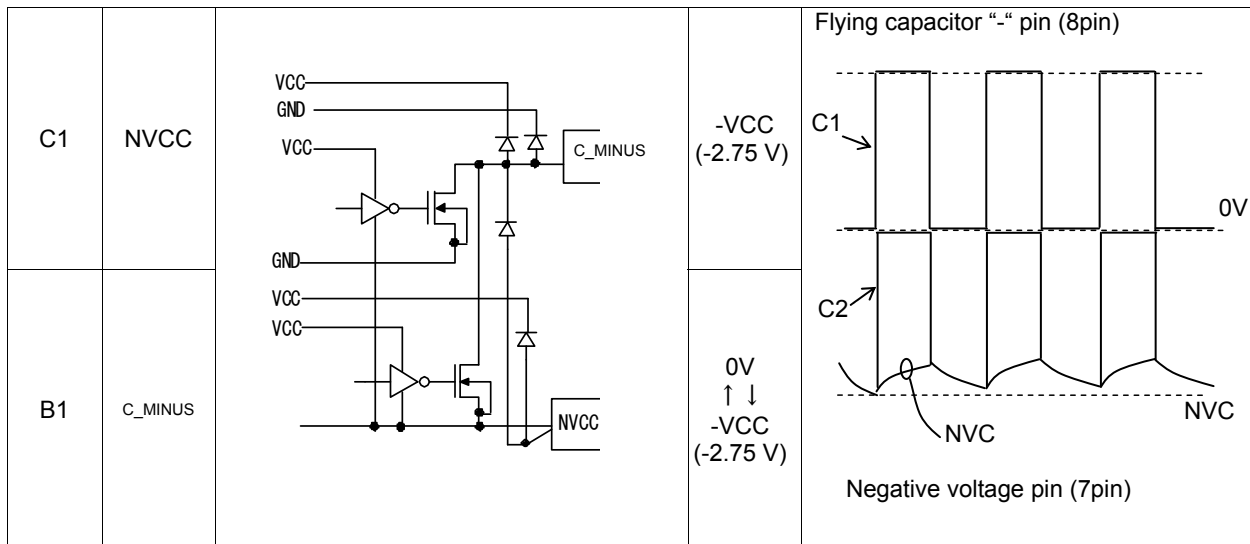
※Use of the BH76706GU with the STBY pin OPEN is inappropriate

● Pin Descriptions

Ball	Pin Name	Pin Internal Equivalent Circuit Diagram	DC Voltage	Functional Description														
A1	C_PLUS		+VCC ↑ ↓ 0V	Flying capacitor “+” pin See functional descriptions of 7pin, 8pin														
A2	VCC		VCC	VCC pin														
A3	VIN		0V	Video signal input pin  Suitable input signals include composite video signals, chroma signals, R.G.B. signals														
B3	STBY	BH769xxGU BH76706GU 	VCC to 0V	ACTIVE/STANBY switching pin<table><tr><th>Pin Voltage</th><th>MODE</th></tr><tr><td>1.2 V ~ VCC (H)</td><td>ACTIVE</td></tr><tr><td>0 V ~ 0.45 V (L)</td><td>STANBY</td></tr></table> MODE switching pin<table><tr><th>Pin Voltage</th><th>MODE</th></tr><tr><td>2.8 V ~ VCC (H)</td><td>STANBY</td></tr><tr><td>1.3 V ~ 1.7 V (M)</td><td>GND (Record)</td></tr><tr><td>0 V ~ 0.2 V (L)</td><td>ACTIVE (Playback)</td></tr></table>	Pin Voltage	MODE	1.2 V ~ VCC (H)	ACTIVE	0 V ~ 0.45 V (L)	STANBY	Pin Voltage	MODE	2.8 V ~ VCC (H)	STANBY	1.3 V ~ 1.7 V (M)	GND (Record)	0 V ~ 0.2 V (L)	ACTIVE (Playback)
Pin Voltage	MODE																	
1.2 V ~ VCC (H)	ACTIVE																	
0 V ~ 0.45 V (L)	STANBY																	
Pin Voltage	MODE																	
2.8 V ~ VCC (H)	STANBY																	
1.3 V ~ 1.7 V (M)	GND (Record)																	
0 V ~ 0.2 V (L)	ACTIVE (Playback)																	
C3	VOUT		0V	Video signal output pin  														
C2	GND		0V	GND pin														

Note 1) DC voltages in the figure are those when VCC = 3.0 V. Moreover, these values are reference values which are not guaranteed.

Note 2) Numeric values in the figure are settings which do not guarantee ratings.



Note 1) DC voltages in the figure are those when $V_{CC} = 3.0\text{ V}$. Moreover, these values are reference values which are not guaranteed.

Note 2) Numeric values in the figure are settings which do not guarantee ratings.

●Description of Operation

1) Principles of output coupling capacitorless video drivers

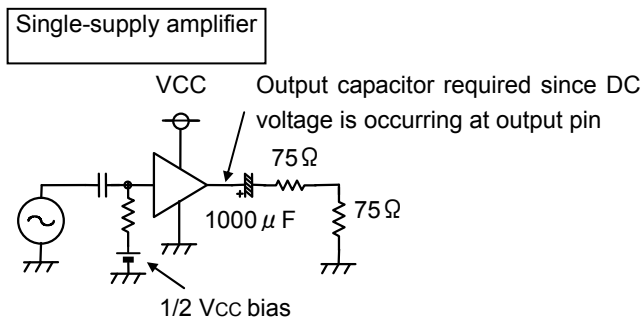


Fig.3

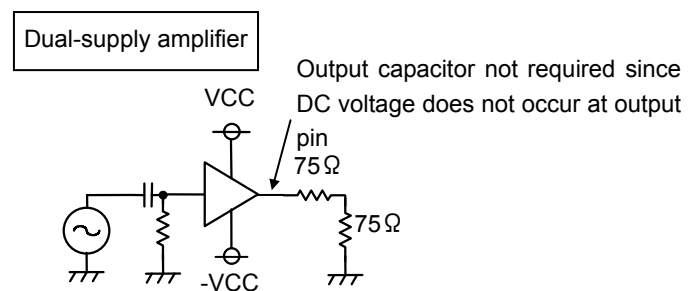


Fig.4

For an amplifier operated from a single power supply (single-supply), since the operating point has a potential of approximately $1/2 V_{CC}$, a coupling capacitor is required for preventing direct current in the output. Moreover, since the load resistance is $150\ \Omega$ ($75\ \Omega + 75\ \Omega$) for the video driver, the capacity of the coupling capacitor must be on the order of $1000\ \mu\text{F}$ if you take into account the low band passband. (Fig.3)

For an amplifier operated from dual power supplies ($\pm$ supply), since the operating point can be at GND level, a coupling capacitor for preventing output of direct current is not needed.

Moreover, since a coupling capacitor is not needed, in principle, there is no lowering of the low band characteristic at the output stage. (Fig.4)

2) Occurrence of negative voltage due to charge pump circuit

A charge pump, as shown in Fig. 5, consists of a pair of switches (SW1, SW2) and a pair of capacitors (flying capacitor, anchor capacitor). Switching the pair of switches as shown in Fig. 5 causes a negative voltage to occur by shifting the charge in the flying capacitor to the anchor capacitor as in a bucket relay.

In this IC, by applying a voltage of $+3\text{ V}$, a negative voltage of approximately -2.8 V is obtained.

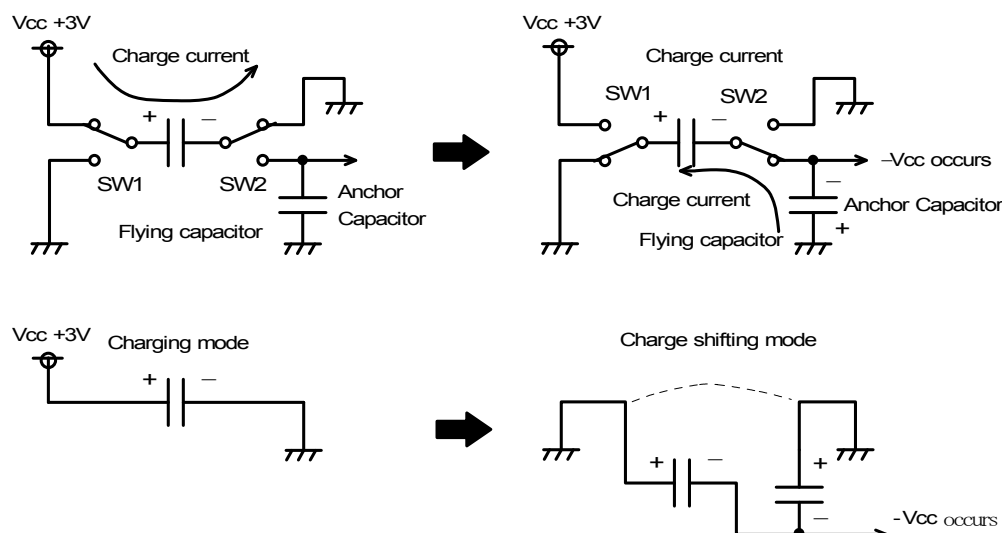


Fig.5 Principles of Charge Pump Circuit

3) Configuration of BH769xxGU and BH76706GU

As shown in Fig. 6, a BH769xxGU or BH76706GU is a dual-supply amplifier and charge pump circuit integrated in one IC. Accordingly, while there is +3 V single-supply operation, since a dual-supply operation amplifier is used, an output coupling capacitor is not needed.

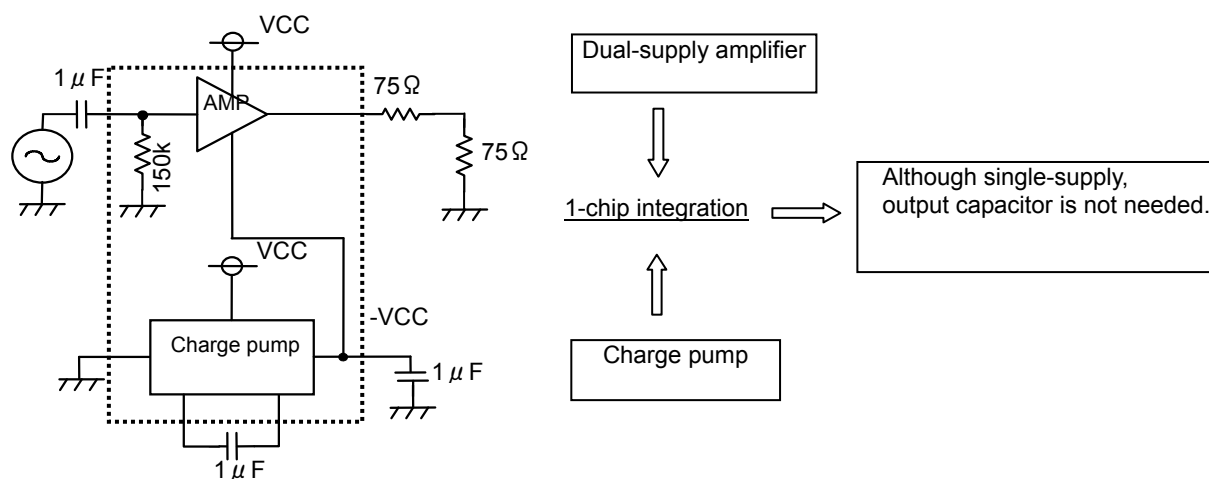


Fig.6 Configuration Diagram of BH769xxGU or BH76706GU

4) Input pin format and sag characteristic

While a BH769xxGU or BH76706GU is a low voltage operation video driver, since it has a large dynamic range of approximately 5.2 Vpp, a resistance termination method that is compatible regardless of signal form (termination by 150 kΩ) is used, and not a clamp method that is an input method exclusively for video signals.

Therefore, since a BH769xxGU or BH76706GU operates normally even if there is no synchronization signal in the input signal, it is compatible with not only normal video signals but also chroma signals and R.G.B. signals and has a wide application range.

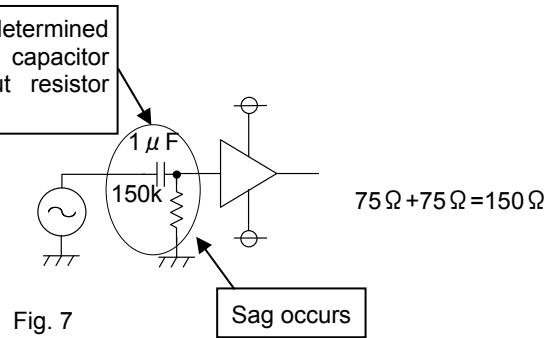
Moreover, concerning sag (lowering of low band frequency) that occurs at the input pin and becomes a problem for the resistance termination method, since the input termination resistor is a high 150 kΩ, even if it is combined with a small capacity input capacitor, a sag characteristic that is not a problem in actual use is obtained.

In evaluating the sag characteristic, it is recommended that you use an H-bar signal in which sag readily stands out. (Fig. 8 to Fig. 10)

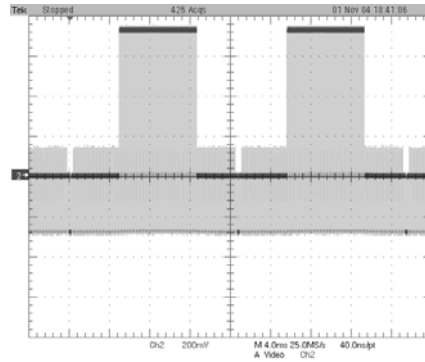
Input capacitor and input impedance cutoff frequency is the same as when output capacitor in generic 75 Ω driver is made 1000 μF .

$1\text{ }\mu\text{F} \times 150\text{ k}\Omega = 1000\text{ }\mu\text{F} \times 150\text{ }\Omega$
(Input pin time constant) (Output pin time constant)

Sag is determined by input capacitor and input resistor only.



a) Video signal without sag (TG-7/1 output, H-bar)



TV screen output image of H-bar signal

Fig. 8

b) BH769xxGU or BH76706GU output (Input = 1.0 μF , TG-7/1 output, H-bar)

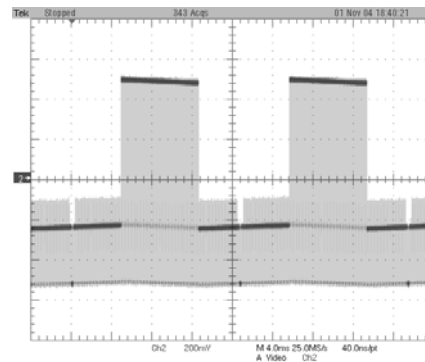
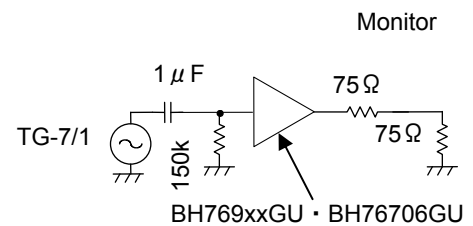


Fig. 9



Nearly identical sag

c) 1000 μF + 150 Ω sag waveform (TG-7/1 output, H-bar)

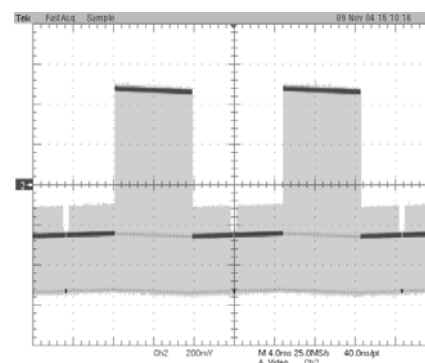
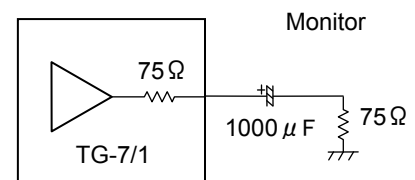
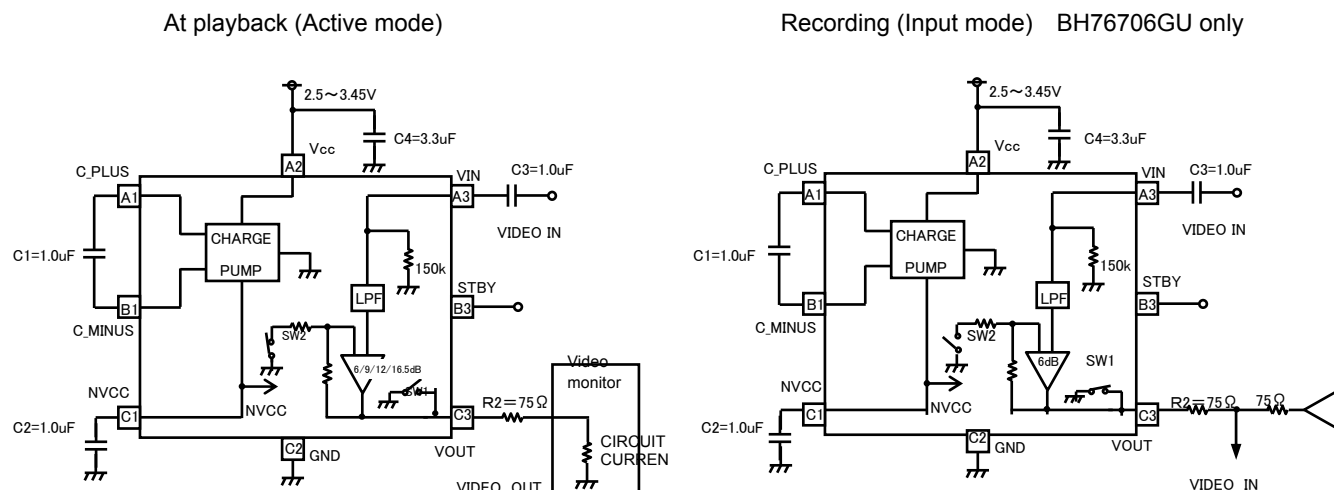


Fig. 10



●Application Circuit Example



* SW1 and SW2 are built-in BH76706GU only

See page 3/16 for STBY pin logic in each mode

Fig.11

※ We are confident in recommending the above application circuit example, but we ask that you carefully check not just the static characteristics but also transient characteristics of this circuit before using it.

●Caution on use

1. Wiring from the decoupling capacitor C4 to the IC should be kept as short as possible. Moreover, this capacitor's capacitance value may have ripple effects on the IC, and may affect the S-N ratio for signals, so we recommend using as large a decoupling capacitor as possible. (Recommended C4: 3.3 μ F, B characteristics, 6.3 V or higher maximum voltage)
Make mount board patterns follow the layout example shown on page 10 as closely as possible.
2. Capacitors to use
In view of the temperature characteristics, etc., we recommend a ceramic capacitor with B characteristics.
3. The NVCC (C1 pin) terminal generates a voltage that is used within the IC, so it should never be connected to a load unless absolutely necessary. Moreover, this capacitor (C2) has a large capacitance value but very little negative voltage ripple.
(Recommended C2: 1.0 μ F, B characteristic, 6.3 V or higher maximum voltage)
4. Capacitors C1 and C4 should be placed as close as possible to the IC. If the wiring to the capacitor is too long, it can lead to intrusion of switching noise. (Recommended C1: 1.0 μ F, B characteristics, 6.3 V or higher maximum voltage)
5. The HPF consists of input coupling capacitor C3 and 150 k Ω of internal input impedance. Be sure to check for video signal sag before determining the C3 value. The cut-off frequency f_c can be calculated using the following formula.
 $f_c = 1/(2\pi \times C3 \times 150k\Omega)$ (Recommended C3: 1.0 μ F, B characteristic, 6.3 V or higher maximum voltage)
6. The output resistor R2 should be placed close to the IC.
7. If the IC is mounted in the wrong direction, there is a risk of damage due to problems such as inverting VCC and GND. Be careful when mounting it.
8. A large current transition occurs in the power supply pin when the charge pump circuit is switched. If this affects other ICs (via the power supply line), insert a resistor (approximately 10 Ω) in the VCC line to improve the power supply's ripple effects. Although inserting a 10 Ω resistor lowers the voltage by about 0.2 V, this IC has a wide margin for low-voltage operation, so dynamic range problems or other problems should not occur. (See Figures 12 to 14.)

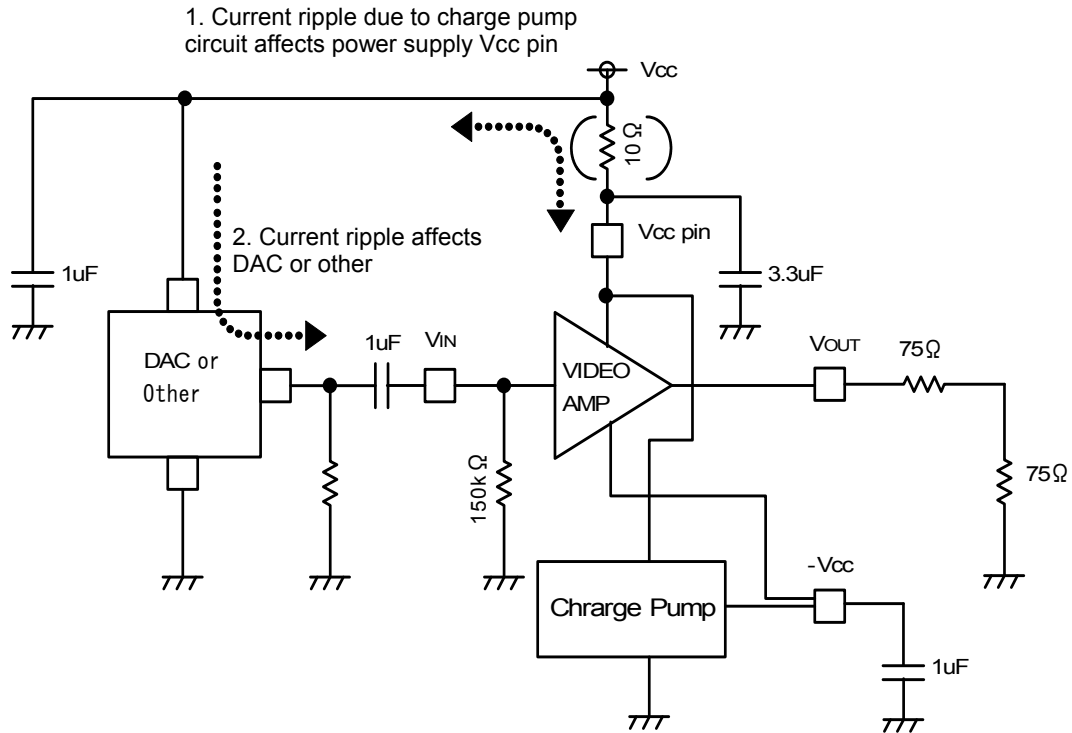


Fig.12 Effects of Charge Pump Circuit Current Ripple on External Circuit

1) Decoupling capacitor only

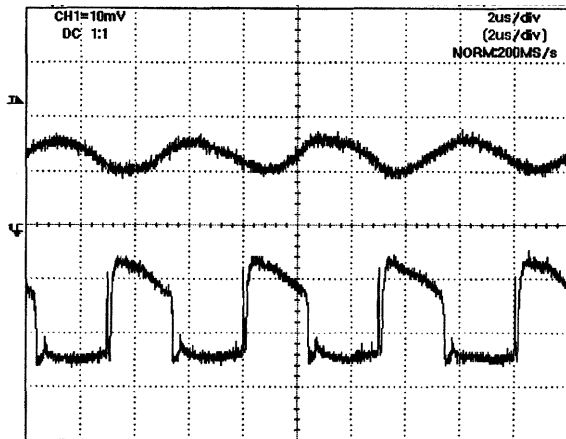
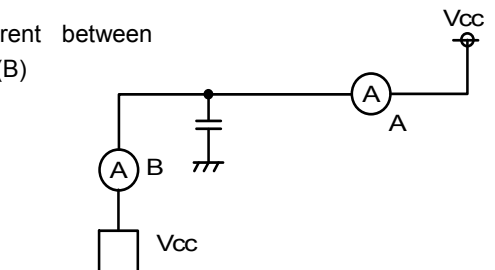


Fig.13

Waveform of current between
power supply and capacitor (A)
10 mA/div

Waveform of current between
capacitor and IC (B)
10 mA/div



2) Decoupling capacitor + 10 Ω resistor

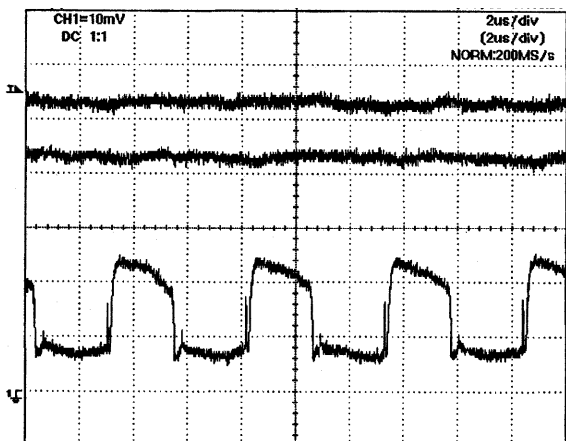
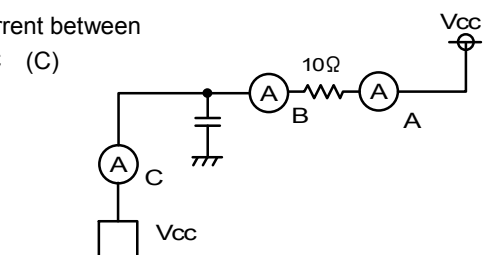


Fig.14

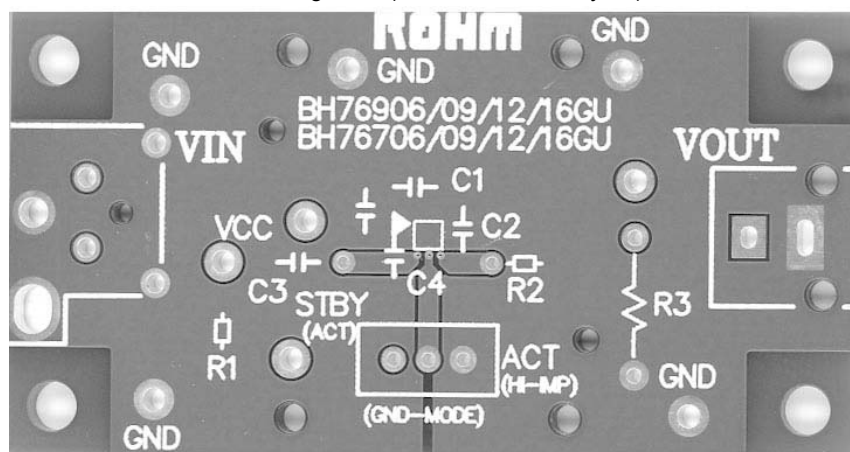
Waveform of current between
power supply and capacitor (A)
10 mA/div

Waveform of current between
resistor and capacitor (B)
10 mA/div

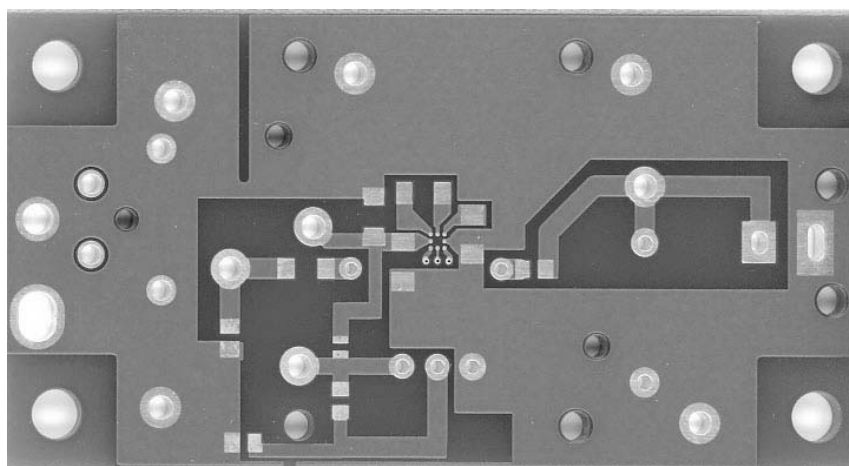
Waveform of current between
capacitor and IC (C)
10 mA/div



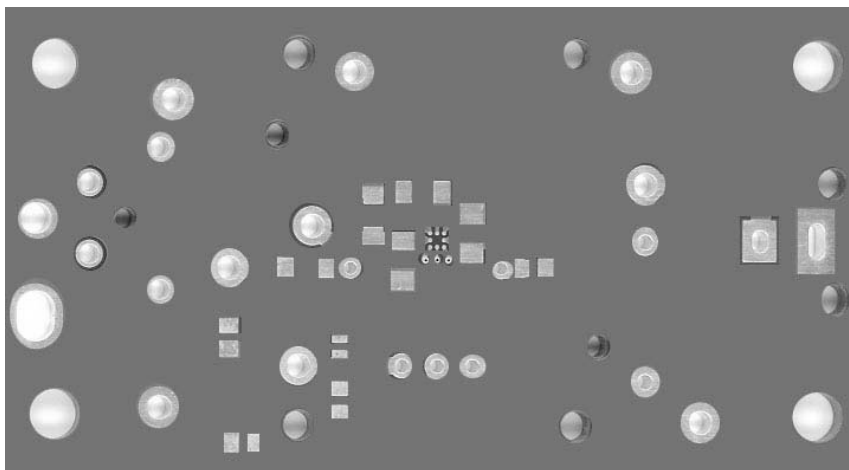
●Evaluation Board Pattern Diagram (Double-sided, 2 layers)



Layer 1 wiring + Silkscreen legend



Layer 2 wiring



Solder pattern

Fig.15

Parts List

Symbol	Function	Recommended Value	Remarks
C1	Flying capacitor	1 μ F	B characteristic recommended
C2	Tank capacitor	1 μ F	B characteristic recommended
C3	Input coupling capacitor	1 μ F	B characteristic recommended
C4	Decoupling capacitor	3.3 μ F	B characteristic recommended
R1	Input termination resistor	75 Ω	Needed when connected to video signal measurement set
R2	Output resistor	75 Ω	—
R3	Output termination resistor	75 Ω	Not needed when connected to TV or video signal measurement set
	Input connector	BNC	
	Output connector	RCA (Pin jack)	

●Reference Data

BH76906GU

Ta=25°C

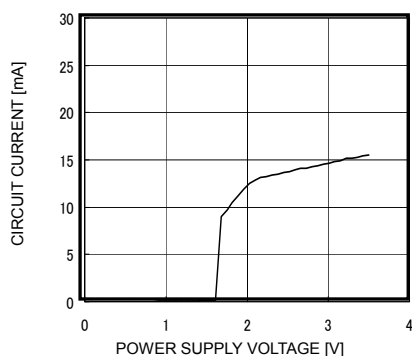


Fig. 16 Circuit Current vs Supply Voltage

BH76906GU

VCC=3V

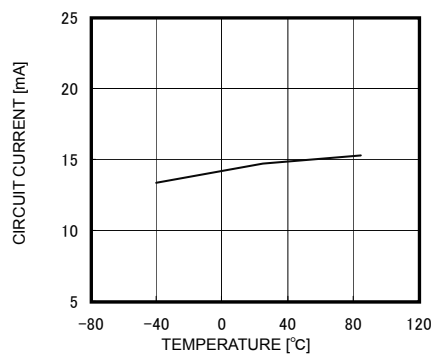


Fig. 17 Circuit Current vs Ambient Temperature

BH76906GU

Ta=25°C

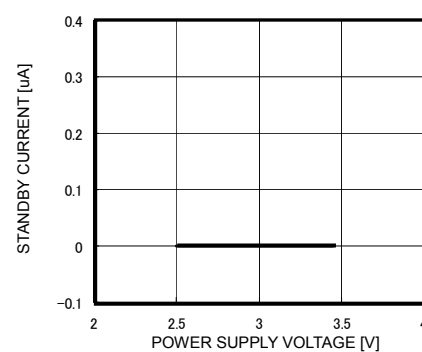


Fig. 18 Standby Circuit Current vs Supply Voltage

BH76906GU

VCC=3V

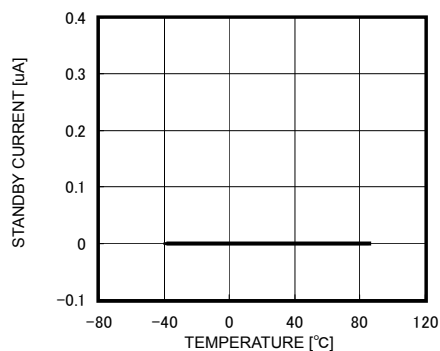


Fig. 19 Standby Circuit Current vs Ambient Temperature

BH76706GU

Ta=25°C

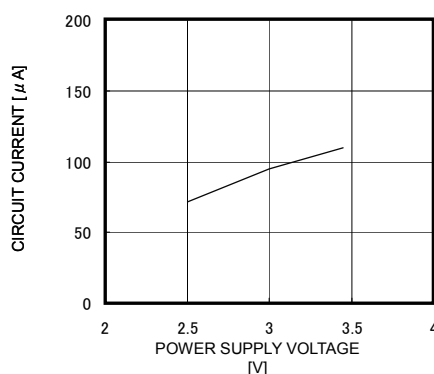
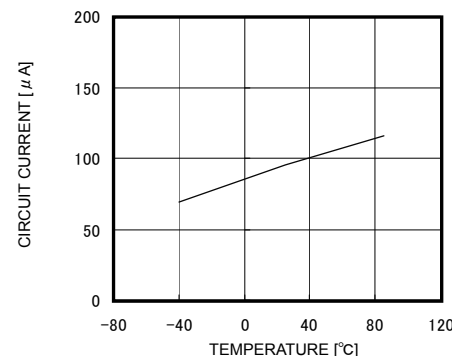


Fig. 20 GND Mode Circuit Current vs Supply Voltage

BH76706GU

VCC=3V



BH76906GU

Ta=25°C

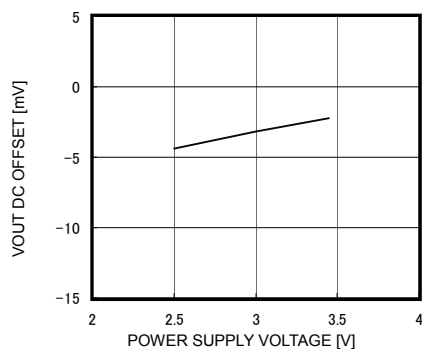


Fig. 22 VOUT Pin Output DC Offset vs Supply Voltage

BH76906GU

VCC=3V

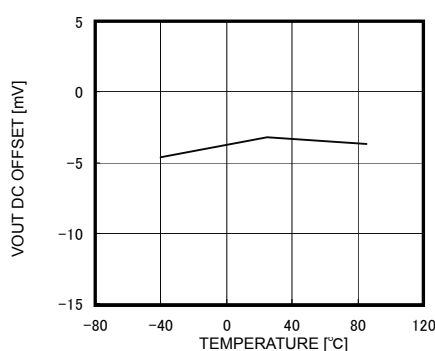


Fig. 23 VOUT Pin Output DC Offset vs Ambient Temperature

BH76906GU

VCC=3V Ta=25°C

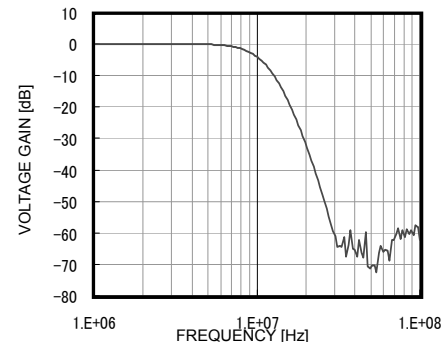


Fig. 24 Frequency Characteristic

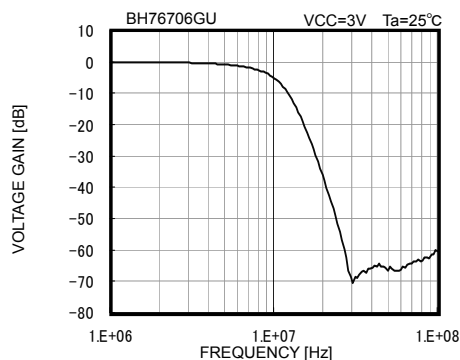


Fig. 25 Frequency Characteristic

BH76906GU

Ta=25°C

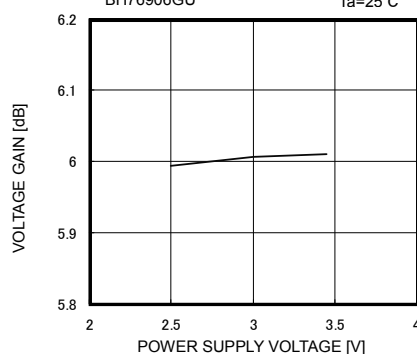


Fig. 26 Voltage Gain vs Supply Voltage

BH76906GU

VCC=3V

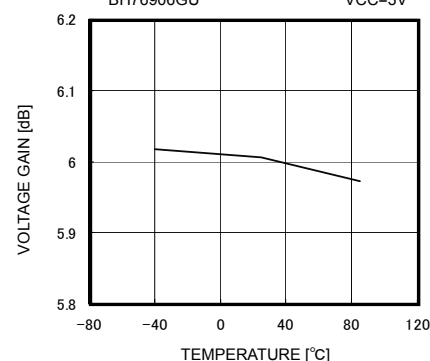


Fig. 27 Voltage Gain vs Ambient Temperature

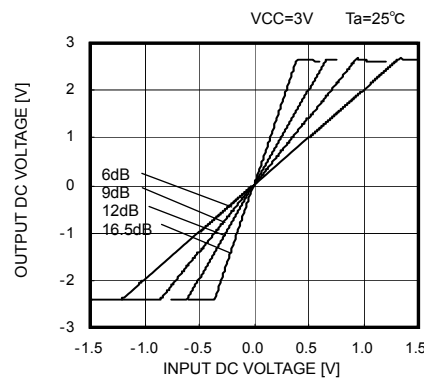
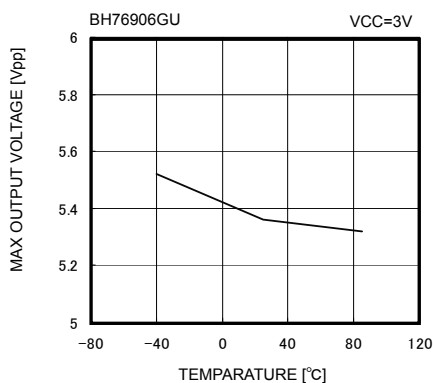
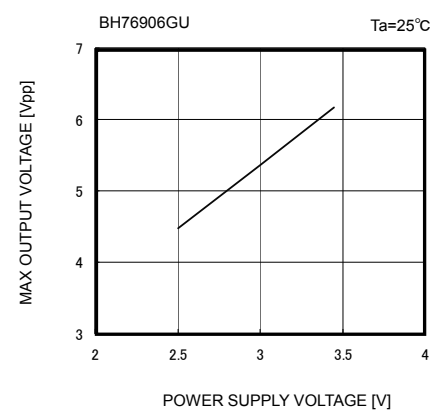
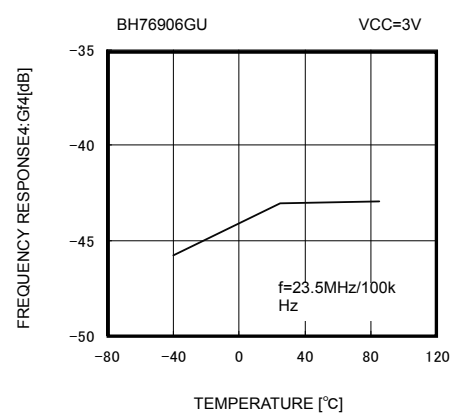
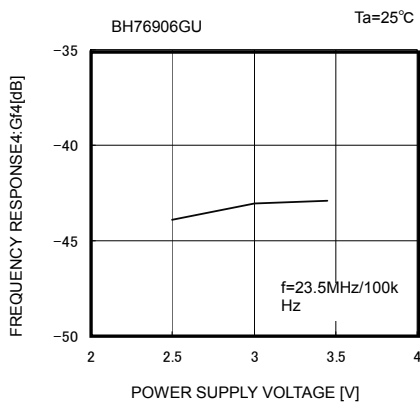
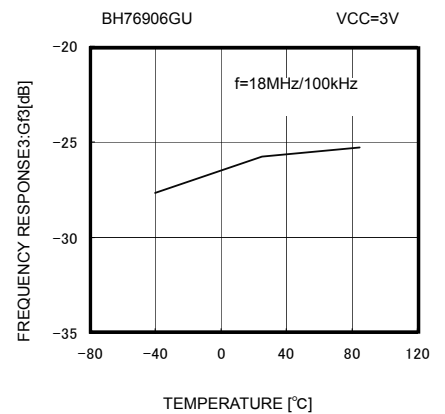
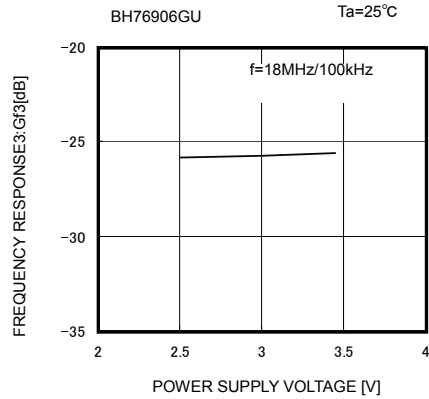
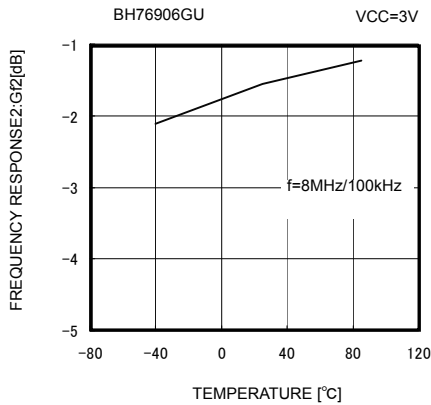
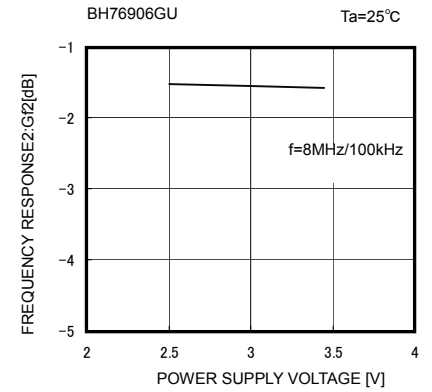
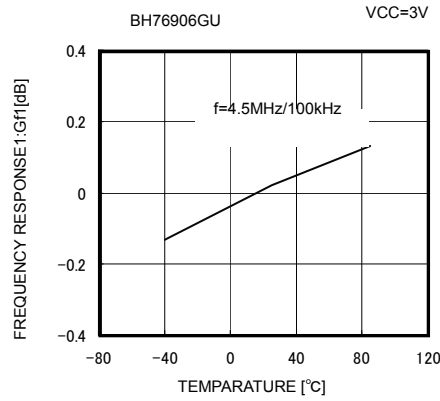
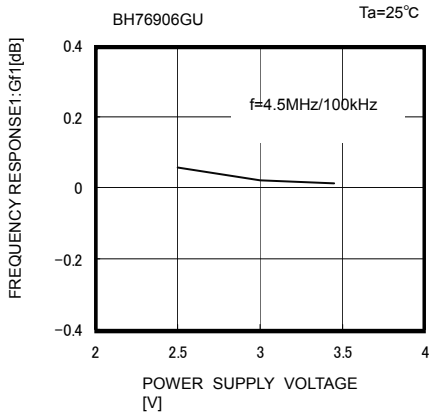


Fig. 37 Max. Output Level vs Ambient Temperature

Fig. 38 DC I/O Characteristic

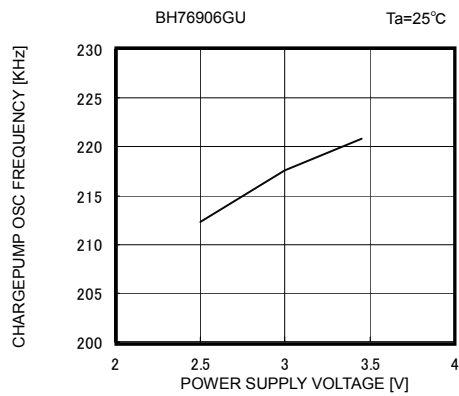


Fig. 39 Charge Pump Oscillation Frequency vs Supply Voltage

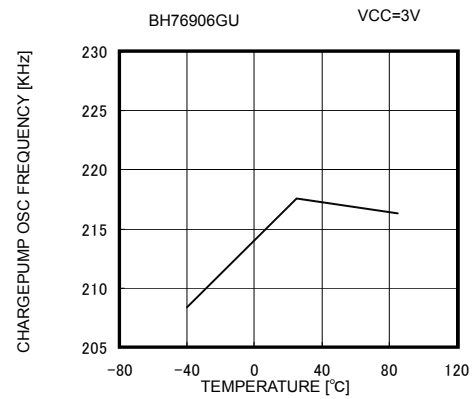


Fig. 40 Charge Pump Oscillation Frequency vs Ambient Temperature

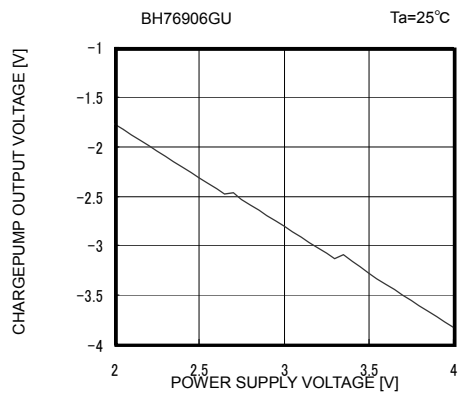


Fig. 41 Charge Pump Output Voltage vs Supply Voltage

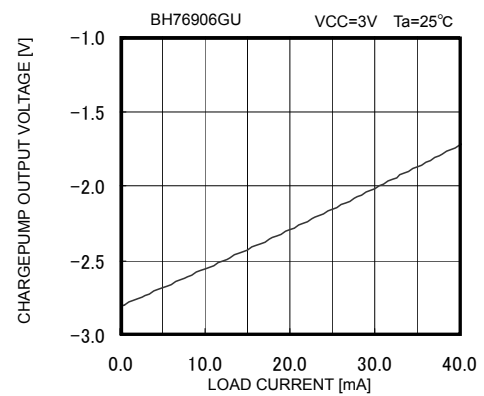


Fig. 42 Charge Pump Load Regulation

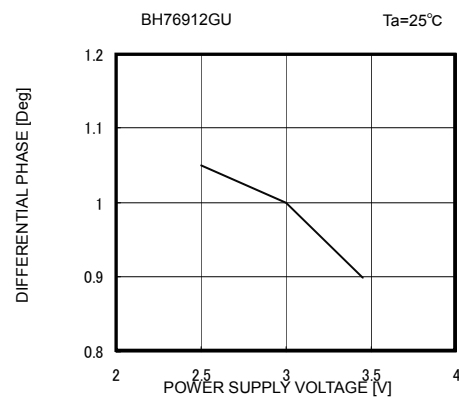


Fig. 43 Differential Phase vs Supply Voltage

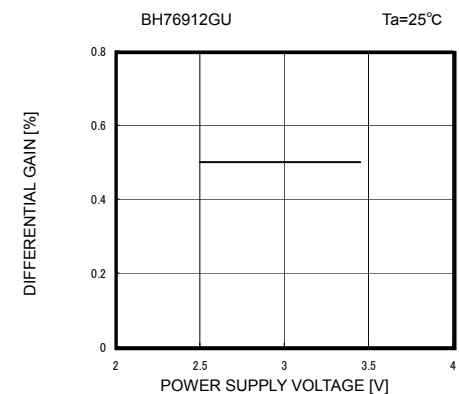
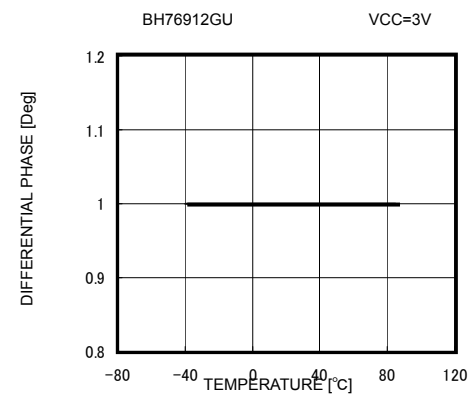


Fig. 45 Differential Gain vs Supply Voltage

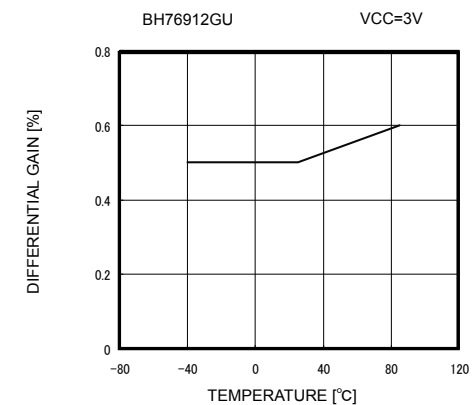


Fig. 46 Differential Gain vs Ambient Temperature

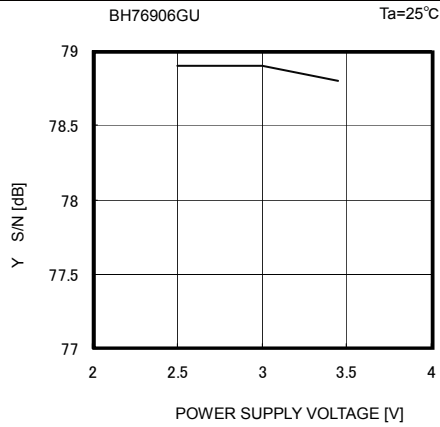


Fig. 47 Y S/N vs Supply Voltage

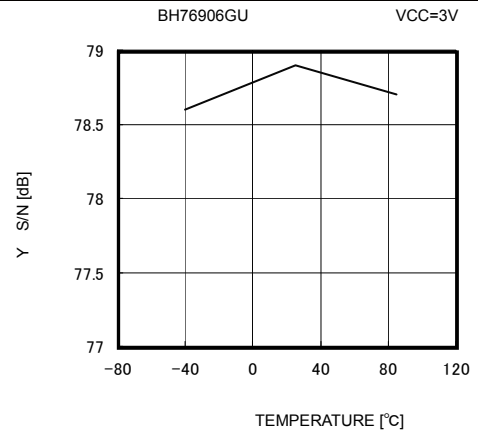


Fig.48 Y S/N vs Ambient Temperature

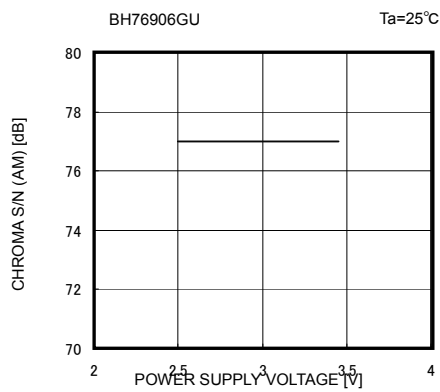


Fig. 49 C AM S/N vs Supply Voltage

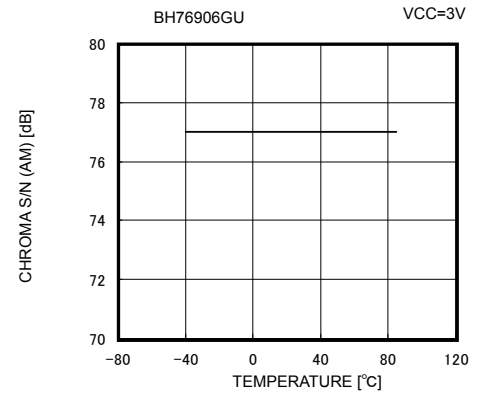


Fig. 50 C AM S/N vs Ambient Temperature

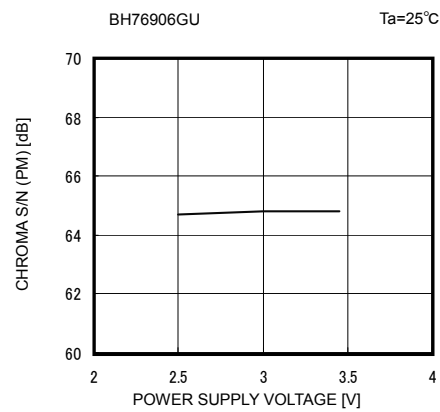


Fig. 51 C PM S/N vs Supply Voltage

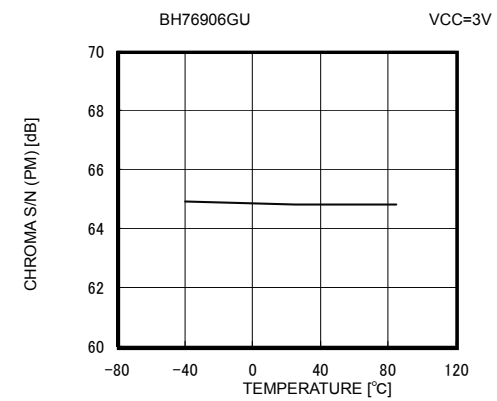


Fig. 52 C PM S/N vs Ambient Temperature

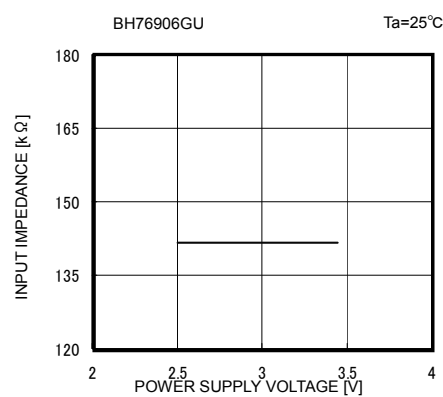


Fig. 53 Input Impedance vs Supply Voltage

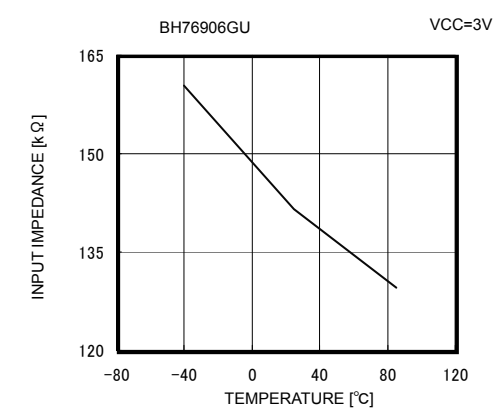


Fig. 54 Input Impedance vs Ambient Temperature

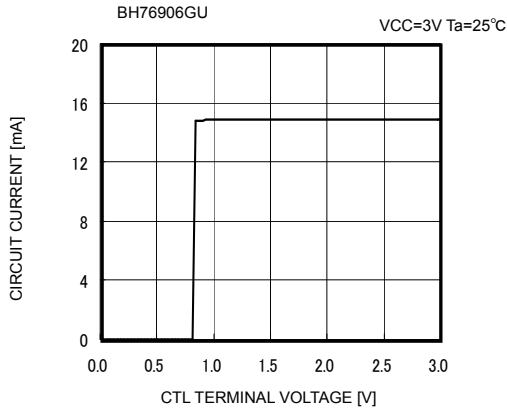


Fig. 55 Control Pin Characteristic

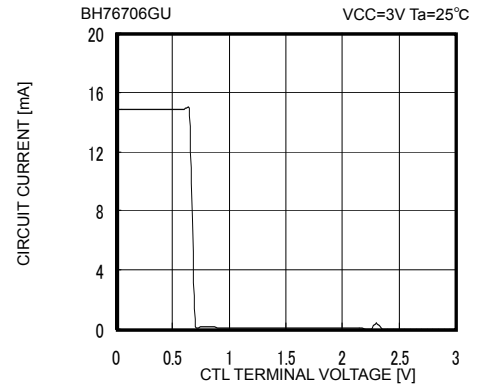


Fig. 56 Control Pin Characteristic

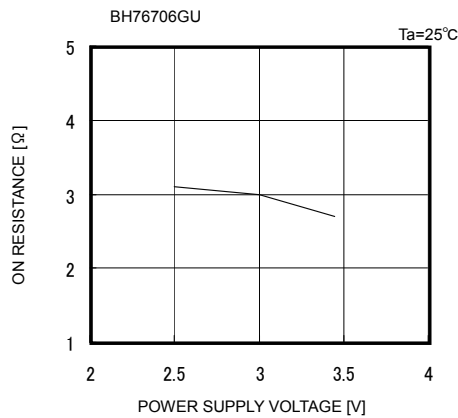


Fig. 57 Output Pin Shunt Switch On Resistance vs Supply Voltage

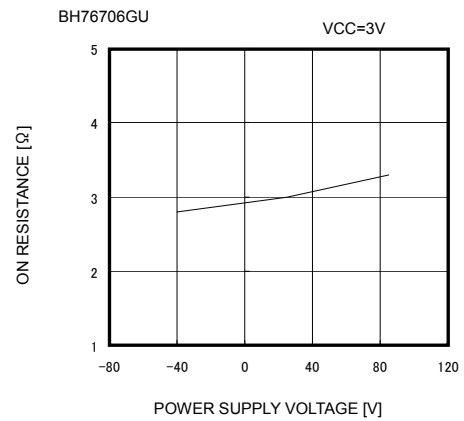


Fig. 58 Output Pin Shunt Switch On Resistance vs Ambient Temperature

● Performing separate electrostatic damage countermeasures

When adding an externally attached electrostatic countermeasure element to the output pin, connect a varistor in the position shown in Fig. 59 (if connected directly to the output pin, the IC could oscillate depending on the capacity of the varistor). For this IC, since the output waveform is GND-referenced and swings positive and negative, a normal Zener diode cannot be used.

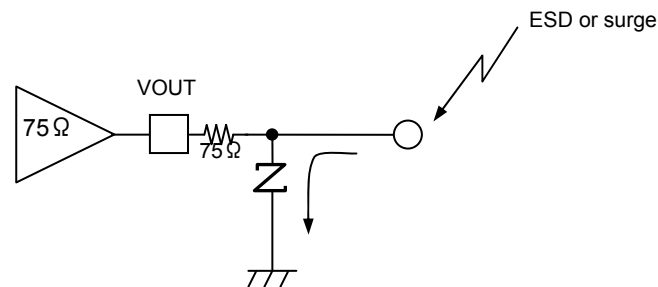


Fig.59 Using Externally Attached Varistor

●Selection of order type

B

H

7

6

9

0

6

G

U

—

E

2

Part. No.

BH76906GU
BH76909GU
BH76912GU
BH76916GU
BH76706GU

Tape and Reel information

VCSP85H1

<Dimension>

(Unit:mm)

Tape	Embossed carrier tape
Quantity	3000pcs
Direction of feed	E2 (The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand)

Reel

1pin

Direction of feed

※When you order , please order in times the amount of package quantity.

Notes

No copying or reproduction of this document, in part or in whole, is permitted without the consent of ROHM Co.,Ltd.

The content specified herein is subject to change for improvement without notice.

The content specified herein is for the purpose of introducing ROHM's products (hereinafter "Products"). If you wish to use any such Product, please be sure to refer to the specifications, which can be obtained from ROHM upon request.

Examples of application circuits, circuit constants and any other information contained herein illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

Great care was taken in ensuring the accuracy of the information specified in this document. However, should you incur any damage arising from any inaccuracy or misprint of such information, ROHM shall bear no responsibility for such damage.

The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM and other parties. ROHM shall bear no responsibility whatsoever for any dispute arising from the use of such technical information.

The Products specified in this document are intended to be used with general-use electronic equipment or devices (such as audio visual equipment, office-automation equipment, communication devices, electronic appliances and amusement devices).

The Products specified in this document are not designed to be radiation tolerant.

While ROHM always makes efforts to enhance the quality and reliability of its Products, a Product may fail or malfunction for a variety of reasons.

Please be sure to implement in your equipment using the Products safety measures to guard against the possibility of physical injury, fire or any other damage caused in the event of the failure of any Product, such as derating, redundancy, fire control and fail-safe designs. ROHM shall bear no responsibility whatsoever for your use of any Product outside of the prescribed scope or not in accordance with the instruction manual.

The Products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability the failure or malfunction of which may result in a direct threat to human life or create a risk of human injury (such as a medical instrument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel-controller or other safety device). ROHM shall bear no responsibility in any way for use of any of the Products for the above special purposes. If a Product is intended to be used for any such special purpose, please contact a ROHM sales representative before purchasing.

If you intend to export or ship overseas any Product or technology specified herein that may be controlled under the Foreign Exchange and the Foreign Trade Law, you will be required to obtain a license or permit under the Law.



Thank you for your accessing to ROHM product informations.
More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

<http://www.rohm.com/contact/>